# **Haptics**

# Solutions for ERM and LRA Actuators

# TEXAS INSTRUMENTS

# **Overview**

Texas Instruments is the leader in driver technology for haptic applications. Our drivers increase performance and decrease integration time of haptics into your system. Only TI offers a total touch solution with a complete portfolio of haptic drivers for any application.

The eccentric rotating mass (ERM) motor and linear resonant actuator (LRA) are two of the most common types of haptic actuators used in the market today. TI driver technology improves the tactile experience by actually improving the performance of these actuators.

# **Solution Characteristics to Consider**

• Response Time – the start and stop time of the actuator



# ERM & LRA Drivers

These features, only available from TI, help improve actuator performance and reduce integration time.



Waveform Library

123 haptic effects embedded, royalty free



Auto-Resonance Detection

Automatically track the resonant frequency of an LRA; maximize vibration strength and improve consistency across devices



# Audio-to-Haptics

Convert audio signals to haptic effects; automatic haptics for music, games, and movies



Automatic Diagnostics Automatically detect the status of the actuator



# Automatic Calibration Automatically detect and configure the closed-loop feedback coefficients for e

closed-loop feedback coefficients for every actuator



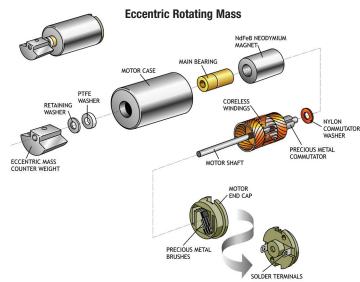
# Closed Loop Feedback

Improve the response time of ERM and LRA actuators with automatic overdrive and braking

# ti.com/touch

# Haptics Solutions for ERM and LRA Actuators

# ERM vs LRA



# **Eccentric Rotating Mass**

- Drive: DC, 1 V 5 V
- Frequency and amplitude are dependent

# **Smart Loop Architecture**

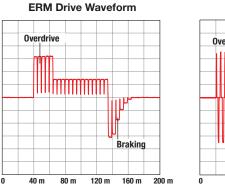
- Automatic Overdrive faster start time with controlled startup
- Automatic Braking quicker stopping with active braking
- Automatic Level Calibration provide consistent feel across actuators
- Actuator Diagnostics easily check the status of the actuator

# ANG 32 FLYING FLEX PCB VOICE COIL MOVING MASS WAVE SPRING WAVE SPRING WAVE SPRING WOULD COULYOKE NEFEB NEODYNIUM MAGNET

Images courtesy of Precision Microdrives

# **Linear Resonant Actuator**

- Drive: AC, 2 Vrms
- An LRA has a resonant frequency due to the spring and mass mechanics; amplitude modulation is very easy
- Up to 2x more force and 50% less power with TI drivers



# 

Braking

160 m

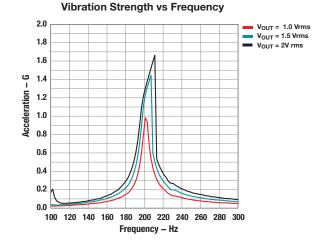
200 m

LRA Drive Waveform

40 m

80 m

120 m



# Auto-Resonance

- An LRA has a narrow operating bandwidth centered around the resonant frequency
- The LRA resonant frequency will vary due to numerous external factors including mounting position and acceleration (see graph to the left)
- TI's auto-resonance eliminates the need to know the resonant frequency
- Auto-resonance tracking provide consistent and strong vibration across all actuators

# Linear Resonant Actuator

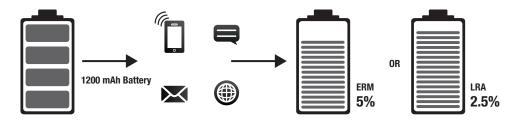
# Haptics Solutions for ERM and LRA Actuators

# **Driver Selection Table**

Features	DRV2603	DRV2604	DRV2605	DRV2605 (1.8 V)
ERM and LRA Drive Modes	~	~	~	v
Drive Strength Independent of Supply	~	~	~	~
Efficient H-Bridge Driver Implementation	~	~	~	~
Automatic Input Level Translation	~	~	~	~
LRA Auto Resonance Tracking and Smart Loop	~	~	~	~
I <sup>2</sup> C Control for Device Parameters		~	~	~
ERM Mode With Smart Loop		~	~	~
Automatic Actuator Calibration and Diagnostic		~	~	~
External Trigger Mode and Multi-Device Trigger		~	~	~
Waveform RAM (2 kB)		~		
Real-Time I <sup>2</sup> C Playback Mode		~	~	~
Integrated Immersion Library			~	~
Audio-to-Haptics			~	V
1.8 V Support				V
Package Type	QFN	WCSP	WCSP	QFN

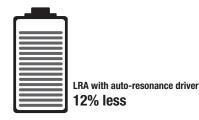
# **Power Consumption**

Starting with a 1200 mAh smartphone battery and running a typical use case scenario of phone calls, email, messaging, and browsing the power consumption results show that an **LRA consumes less power** and is inherently more efficient than an ERM.



# Effects of Auto-Resonance on Power Consumption

It was also found that an LRA consumes less power when driven intelligently by an auto-resonance driver versus a driver with static frequency control.



# **Design Resources and Reference**

E2E Touch Forum ti.com/touchforum



# ERM & LRA Evaluation Kits - \$99

- Demo or characterize the DRV2603, DRV2604, or DRV2605 using the CapSense evaluation kit
- Includes an ERM and LRA motor
- Trigger effects using the six MSP430 CapSense buttons
- Programmable MSP430 to create haptic waveforms and control the driver
- Available evaluation kits: DRV2603EVM-CT, DRV2604EVM-CT, and DRV2605EVM-CT



# **ERM / LRA Applications**

# Smartphone

- Add haptics to enhance the user interface
- Increase the performance of the existing silent alert actuators by adding haptics

# Tablet / E-reader

- Add advanced UI haptics to enhance the user experience
- Add more practical feedback to the capacitive touch button home keys on Windows 8<sup>®</sup> and Android<sup>™</sup>

# Accessories

- Capacitive touch mice with haptics
- Television remotes with haptics
- · Laptop or free-standing mouse touch pads with haptics

# See TI's complete portfolio of solutions for touch technology at ti.com/touch

- Innovative haptics products for touch-screen enabled devices
- Cool solutions for buttons, sliders, and wheels featuring MSP430
- Touch screen controllers for a broad range of performance options



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